



Material Content Data Sheet



Sales Product Name		IPD60R950C6		Issued		27. December 2016			
MA#		MA000974302							
Package		PG-TO252-3-341		Weight*		381.96 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	2.144	0.56	0.56	5612	5612	
leadframe	non noble metal	iron	7439-89-6	0.248	0.06		650		
	inorganic material	phosphorus	7723-14-0	0.075	0.02		195		
	non noble metal	copper	7440-50-8	248.124	64.98	65.06	649612	650457	
wire	non noble metal	aluminium	7429-90-5	4.339	1.14	1.14	11359	11359	
encapsulation	inorganic material	antimonytrioxide	1309-64-4	1.687	0.44		4418		
	plastics	brominated resin	-	1.808	0.47		4734		
	organic material	carbon black	1333-86-4	1.929	0.50		5049		
	plastics	epoxy resin	-	16.272	4.26		42602		
	inorganic material	silicondioxide	60676-86-0	98.837	25.88	31.55	258766	315569	
leadfinish	non noble metal	tin	7440-31-5	3.740	0.98	0.98	9792	9792	
plating	non noble metal	nickel	7440-02-0	0.509	0.13	0.13	1332	1332	
solder	noble metal	silver	7440-22-4	0.056	0.01		147		
	non noble metal	tin	7440-31-5	0.045	0.01		118		
	non noble metal	lead	7439-92-1	2.144	0.56	0.58	5614	5879	
*deviation	< 10%					Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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